










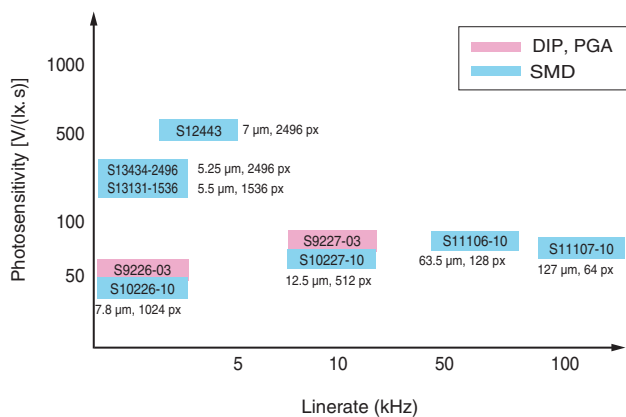
Image sensors for industrial applications

CMOS image sensors

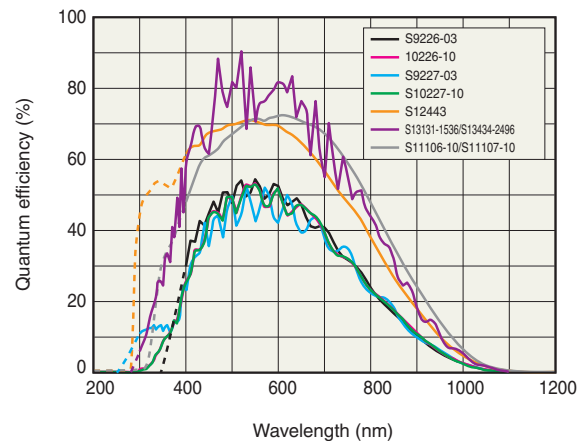
Parameter	S9226-03 ^{*1*}	S10226-10 ^{*1*}	S9227-03	S10227-10	S12443	S13131-1536 ^{*3}	S13434-2496	S11106-10 ^{*2}	S11107-10 ^{*2}	Unit
Package	Ceramic DIP	Resin mold SMD	Ceramic DIP	Resin mold SMD	Resin mold SMD	Resin mold SMD	Resin mold SMD	Resin mold SMD	Resin mold SMD	-
Package size	12.0 × 7.87	9.1 × 2.4	12.0 × 7.87	9.1 × 4.4	23 × 2.7	9.1 × 2.4	13.8 × 2.1	9.1 × 2.4	9.1 × 2.4	mm
Appearance										-
Output	Monochrome		Monochrome		Monochrome			Monochrome		-
Supply voltage	3.3 to 5		5		3.3			3 to 5		V
Analog/digital	Analog		Analog		Analog			Analog		-
Number of pixels	1024		512		2496	1536	2496	128	64	pixel
Pixel pitch	7.8		12.5		7	5.5	5.25	63.5	127	μm
Pixel height	125		250		125	63.5	63.5	63.5	127	μm
Image size	7.9872 × 0.125		6.4 × 0.25		17.472 × 0.125	8.448 × 0.0635	13.104 × 0.0635	8.06 × 0.0635	8.06 × 0.127	mm
Video data rate max.	0.2		5		10	2	2	10		MHz
Line rate max.	0.194		9.4		3.9	1.3	0.8	64.9	111	kHz
Photosensitivity	50		80		500	280	280	80	75	V/(lx.s)
Conversion efficiency	3.2		1.6		25	45	45	0.75	0.35	μV/e ⁻
Dark output voltage ^{*4}	0.8		1.0		0.4	1.5	1.5	0.02	0.04	mV
Dark current	5		10		0.26	0.53	0.53	0.43	1.83	fA
Saturation output	3.2		4.3		2	1.4	1.4	4		V
	1000		2688		80	31	31	5333	11429	ke ⁻
Readout noise	1.4		0.45		1.2	0.4	0.4	0.7	0.6	mV rms
	438		281		48	9	9	933	1714	e ⁻ rms
Dynamic range	2280		9550		1670	3500	3500	5700	6600	-
A/D converter	None									
Anti-blooming function	Possible									
Electronic shutter function	Impossible		Possible							
Readout of every pixel	Sequential		Simultaneous							

*1: High gain operation *2: 5 V operation *3: S13131-512 (512 pixels) and S13131-736 (736 pixels) are also available. *4: Integration time = 10 ms

■ Photosensitivity vs. line rate



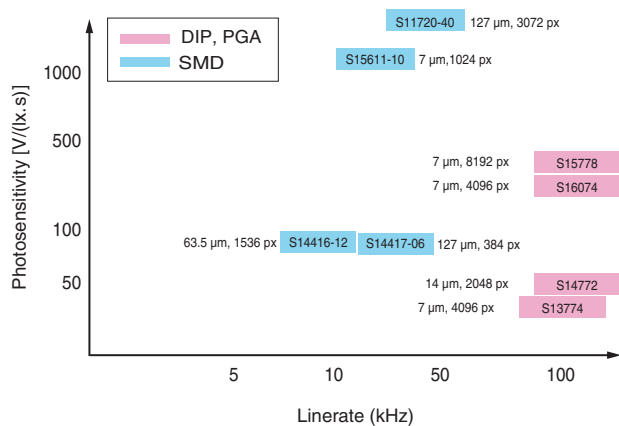
■ Spectral response (typical examples)



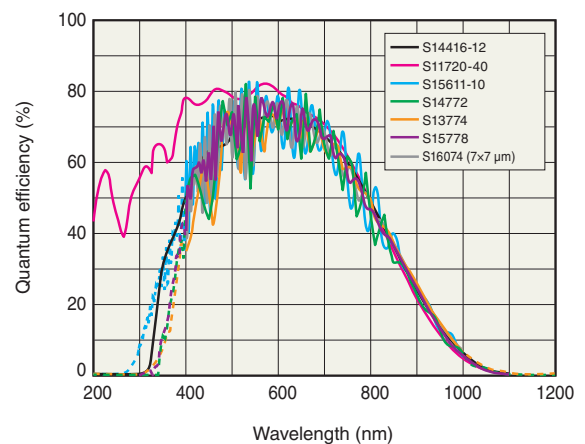
Parameter	S14416-12*1	S14417-06*2	S11720-40*3	S15611-10*4	S14772*5	S13774*5	S15778*5	S16074*5	Unit
Package	Resin mold SMD		Resin mold SMD	Resin mold SMD	Ceramic PGA	Ceramic PGA	Glass epoxy and FeNiCo alloy	Ceramic DIP	-
Package size	114 × 10	61.2 × 12.7	396.5 × 18	13 × 5.8	50.5 × 16.5	50.5 × 16.5	70 × 46	38 × 9.91	mm
Appearance									-
Output	Monochrome		Monochrome	Monochrome	Monochrome	Monochrome	Monochrome	Monochrome	-
Supply voltage	5		5	3.3	3.3	3.3	3.3/1.8	3.3	V
Analog/digital	Analog		Digital	Digital	Digital	Digital	Digital	Digital	-
Number of pixels	1536	384	3072	1024	2048	4096	8192	① 4096 ② 3072 ③ 2048	pixel
Pixel pitch	63.5	127	127	7	14	7	7	① 7 ② 9.3 ③ 14	μm
Pixel height	63.5	127	127	200	14	7	7	① 7 ② 9.3 ③ 14	μm
Image size	97.472 × 0.0635	48.768 × 0.127	390.044 × 0.127	7.168 × 0.200	28.672 × 0.014	28.672 × 0.007	57.344 × 0.007	① 28.672 × 0.007 ② 28.672 × 0.0093 ③ 28.672 × 0.014	mm
Video data rate max.	10		90	40	231	180	360	320	MHz
Line rate max.	6.4	24.7	45.4	34	125	100	100*6	① 35 ② 46 ③ 65	kHz
Photosensitivity	80	75	5100	980	430	360	440	① 360 ② 574 ③ 430	V/(lx.s)
Conversion efficiency	0.75	0.35	25	40	100	340	410	① 336 ② 304 ③ 104	μV/e ⁻
Dark output voltage*7	0.02	0.04	250	1.2	1.9	4	4.9	① 4 ② 3.2 ③ 1.9	mV
Dark current	0.43	1.83	160.2	0.48	0.30	0.19	0.19	① 0.19 ② 0.17 ③ 0.29	fA
Saturation output	4		1.4	1.71	1.25	1.25	1.25	1.13	V
	5333	11428	56	43	12.5	3.7	3	① 3.3 ② 3.7 ③ 10.6	ke ⁻
Readout noise	0.7	0.6	0.6	0.63	1.2	1.5	1.5	1.6	mV rms
	933	1714	24	16	12	4.2	3.6	① 4.7 ② 5.2 ③ 15.3	e ⁻ rms
Dynamic range	5700	6600	2333	2700	1100	800	800	1900	-
A/D converter	None		16-bit	12-bit	10-bit/11-bit	10-bit/12-bit	10-bit/11-bit	12-bit	-
Anti-blooming function	Possible								-
Electronic shutter function	Possible								-
Readout of every pixel	Simultaneous								-

*1: S14416-02 (256 pixels) and S14416-06 (768 pixels) are also available. *2: S14417-02 (128 pixels) is also available. *3: S11720-20 (1536 pixels) is also available.
*4: S15611 (ceramic package) is also available. *5: Gain = 8 operation *6: High speed mode *7: Integration time = 10 ms





■ Photosensitivity vs. line rate



■ Spectral response (typical examples)



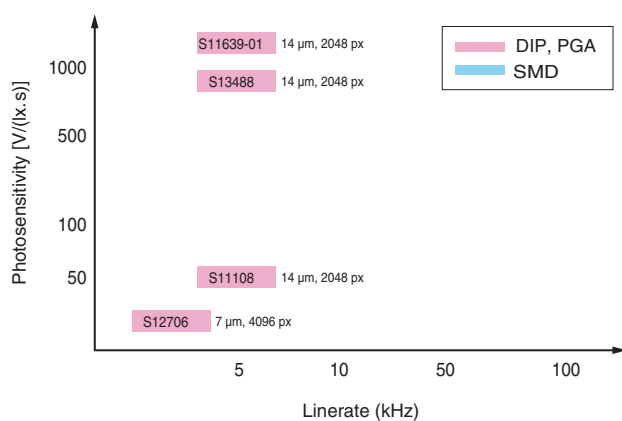
KMPD80616EC

Parameter	S11639-01	S11108	S12706	S13488*1	Unit	
Package	Plastic DIP				-	
Package size	41.6 × 9.1				mm	
Appearance					-	
Output	Monochrome	Monochrome	Monochrome	Color	-	
Supply voltage	5				V	
Analog/digital	Analog				-	
Number of pixels	2048	2048	4096	2048	pixel	
Pixel pitch	14	14	7	14	μm	
Pixel height	200	14	7	42	μm	
Image size	28.672 × 0.2	28.672 × 0.014	28.672 × 0.007	28.672 × 0.42	mm	
Video data rate max.	10	10	10	10	MHz	
Line rate max.	4.6	4.6	2.3	4.6	kHz	
Photosensitivity	1300	50	23	Red	65	V/(lx.s)
				Green	85	
				Blue	35	
Conversion efficiency	25	13	25	125	μV/e-	
Dark output voltage*2	0.2	0.3	0.2	1.5	mV	
Dark current	0.13	0.37	0.13	0.19	fA	
Saturation output	2	1.2	2	4	V	
	80	92	80	32	ke-	
Readout noise	0.4	0.6	1	0.9	mV rms	
	16	46	40	7.2	e- rms	
Dynamic range	5000	2000	2000	4444	-	
A/D converter	None				-	
Anti-blooming function	Possible				-	
Electronic shutter function	Possible				-	
Readout of every pixel	Simultaneous				-	

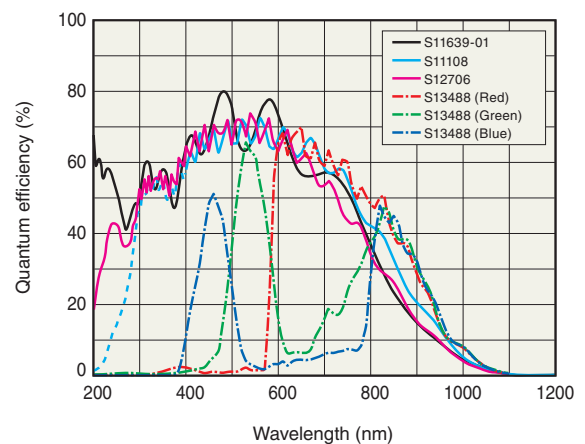
*1: High gain operation, IR cut filter: E-CM500S (t=1.0 mm)

*2: Integration time = 10 ms

■ Photosensitivity vs. line rate

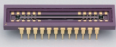
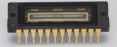






■ Spectral response (typical examples)

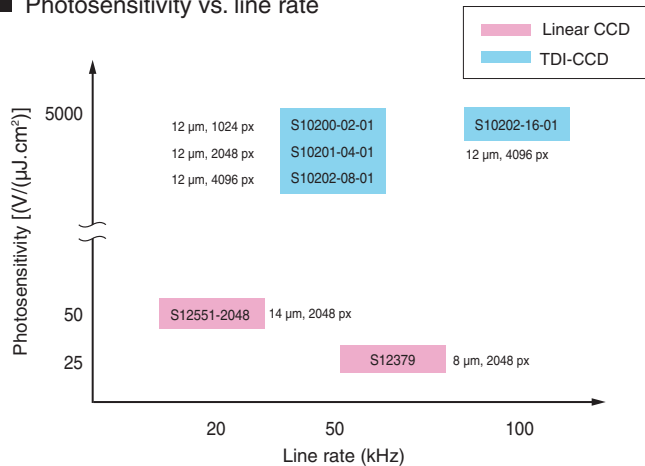


KMPDB0617EA

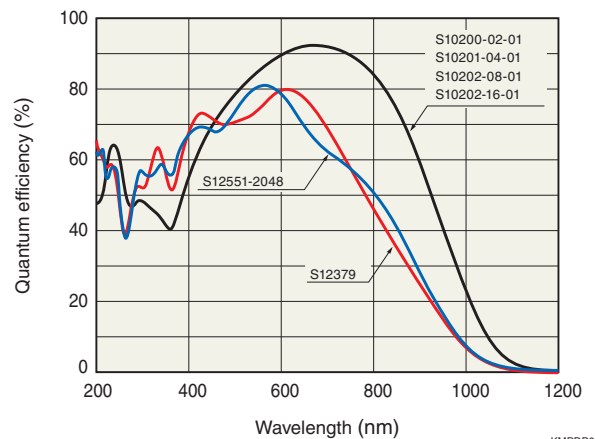
CCD image sensors

Parameter	S12551-2048	S12379	S10200-02-01	S10201-04-01	S10202-08-01	S10202-16-01	Unit
Feature	Easy to use	High speed, Fine pitch	High speed, High sensitivity				-
Type	Interline	Interline	Full Frame Transfer (TDI-CCD)				-
Package size	41.6 × 10.03	36.0 × 12.45	30.48 × 9.91	40.64 × 9.91	66.04 × 9.91	66.04 × 9.91	mm
Appearance							-
Number of pixels	2048	2048	1024	2048	4096	4096	pixels
Stage	1	1	128				-
Pixel pitch	14	8	12				μm
Pixel height	14	8	12				μm
Image size	28.672 × 0.014	16.384 × 0.008	12.288 × 1.536	24.576 × 1.536	49.152 × 1.536		mm
Number of ports	1	4	2	4	8	16	-
Video data rate / port	40	40	30				MHz
Line rate	19 max.	72 max.	50 typ.	50 typ.	50 typ.	100 typ.	kHz
Conversion efficiency	13	21	9.5				μV/e ⁻
Full well capacity	100	20	100				ke ⁻
Readout noise	40	20	35				e ⁻ rms
Dynamic range	2500	1000	2800				-
Photosensitivity (λ=600 nm)	60	32	4800				V/(μJ.cm ²)
Anti-blooming function	Possible	Possible	Possible				-
Electronic shutter function	Possible	Impossible	Impossible				-
Clock terminal	6	4	8				-

■ Photosensitivity vs. line rate



■ Spectral response (typical examples)



KMPDB0404EA

TDI mode

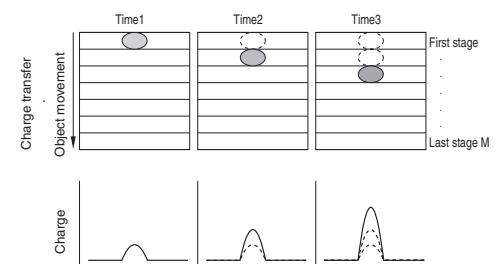
In FFT-CCD, signal charges in each line are vertically transferred during charge readout. TDI mode synchronizes this vertical transfer timing with the movement of the object, so that signal charges are integrated a number of times equal to the number of vertical stages of the CCD pixels. In the TDI mode, the signal charges must be transferred in the same direction at the same speed as those of the object to be imaged. These speeds are expressed by the following equation:

$$v = f \times d$$

v : object moving speed, charge transfer speed f : vertical transfer frequency d : pixel size

In the right figure, when the first stage charges are transferred to the second stage, an additional charges are produced in the second stage by photoelectric conversion and accumulated. When this operation is continuously repeated until reaching the last stage M (the number of vertical stages), signal charges which are M times greater than the initial charges are accumulated. Since the signal charges on each line are output from the CCD horizontal shift register, a two-dimensional image can be continuously acquired. In this way the TDI mode achieves sensitivity which is M times higher than linear image sensors (S/N is improved \sqrt{M} times). The TDI mode also improves sensitivity variations compared to frame mode operation.

☑ Schematic diagram showing integrated exposure by TDI mode



KMPDC0139EA

Type	Type No.	Output	Main features	Applications							
				Position detection of spot light	Detection of edge	Encoder	Barcode reader	Refractometer	Sorting	Machine vision	
CMOS	S9226-03	Mono-chrome	High resp. High speed ES SP SS Low cost UV TDI	●							
	S10226-10		High resp. High speed ES SP SS Low cost UV TDI	●				●			
	S9227-03		High resp. High speed ES SP SS Low cost UV TDI	●	●						
	S10227-10		High resp. High speed ES SP SS Low cost UV TDI	●	●		●	●			
	S12443		High resp. High speed ES SP SS Low cost UV TDI	●	●	●	●				
	S13131-1536		High resp. High speed ES SP SS Low cost UV TDI	●	●	●	●				
	S13434-2496		High resp. High speed ES SP SS Low cost UV TDI	●	●	●	●				
	S11106-10		High resp. High speed ES SP SS Low cost UV TDI	●	●	●		●			
	S11107-10		High resp. High speed ES SP SS Low cost UV TDI	●	●	●		●			
	S14416-12		High resp. High speed ES SP SS Low cost UV TDI	●	●	●					
	S14417-06		High resp. High speed ES SP SS Low cost UV TDI	●	●	●					
	S11720-40		High resp. High speed ES SP SS Low cost UV TDI		●						●
	S15611-10		High resp. High speed ES SP SS Low cost UV TDI	●	●	●				●	
	S14772		High resp. High speed ES SP SS Low cost UV TDI	●	●	●				●	●
	S13774		High resp. High speed ES SP SS Low cost UV TDI	●	●	●				●	●
	S15778		High resp. High speed ES SP SS Low cost UV TDI	●	●	●				●	●
	S16074		High resp. High speed ES SP SS Low cost UV TDI	●	●	●				●	●
	S11639-01		High resp. High speed ES SP SS Low cost UV TDI	●	●						
	S11108		High resp. High speed ES SP SS Low cost UV TDI	●	●	●				●	●
	S12706		High resp. High speed ES SP SS Low cost UV TDI	●	●	●				●	●
S13488	Color	High resp. High speed ES SP SS Low cost UV TDI							●		
CCD	S12551-2048	Mono-chrome	High resp. High speed ES SP SS Low cost UV TDI						●	●	
	S12379		High resp. High speed ES SP SS Low cost UV TDI						●	●	
	S1020x series		High resp. High speed ES SP SS Low cost UV TDI							●	

-  High sensitivity
-  High-speed
-  Electronic shutter function
-  Single power supply
-  Small in size
-  Low cost
-  UV sensitivity
-  TDI operation

Glossary

■ Video data rate

Number of pixels to be output per second

■ Line rate

Number of lines to be output per second, for outputting all pixels in the image sensor.

■ Photosensitivity

Output voltage (unit: V/lx-sec) per incident light level, per second, for Tungstan lump, 2856K.

■ Conversion factor

The conversion efficiency is the charge-to-voltage conversion ratio.

The conversion efficiency (Sv) is expressed by following equation.

$$Sv = q \times \Delta V_{out} / Q$$

q: electron charge, ΔV_{out} : Output voltage, Q: signal charge [C]

■ Saturation output

The difference between output offset voltage and the output voltage when saturated.

■ Full well capacity

The amount of charge when the output is saturated.

■ Readout noise

Readout noise is defined as random noise (lower detection limit) coming from the amplifier in the output section. It should be noted that the total noise includes shot noise etc, as well as readout noise.

■ Dynamic range

Ratio of readout noise and saturation output. The dynamic range (DR) is expressed by following equation.

$$DR = \text{Saturation output} / \text{Readout noise}$$

■ Spectral response

The relation (photoelectric sensitivity) between the incident light level and resulting photocurrent differs depending on the wavelength of the incident light. This relation between the photoelectric sensitivity is referred to as the spectral response characteristic and is expressed in terms of photo sensitivity or quantum efficiency. We usually define the spectral response range as the range in which the relative sensitivity is higher than 5% or 10% of the peak sensitivity.

■ Quantum efficiency

This is the number of electrons or holes that can be extracted as photocurrent divided by the number of incident photons. It is commonly expressed in percent (%). The quantum efficiency QE and photo sensitivity S (unit:A/W) have the following relationship at a given wavelength (unit:nm).

$$QE = S \times 1240 / \lambda \times 100 [\%]$$

■ Blooming

A phenomenon in which the photoelectrically converted signal charge in an image sensor exceeds a certain level and spills over into adjacent pixels or transfer region other than photodiodes (in IT type CCDs). To prevent blooming, some means for discharging excess charge should be implemented.

■ Integration time

In image sensor operation, the electric charge generated by light entering in a given time is accumulated and collected to create a signal. The length of this time during which light enters the image sensor is called integration time or accumulation time. In image sensors with electronic shutter function, the integration time can be set to the order of microsecond.

■ Electronic shutter function

The electronic shutter function can be used to accumulate a signal charge in shorter time than readout period. The start of integration time can be synchronized with an external trigger by using electronic shutter.

■ Pixel integration simultaneity

In the time-series integration method, the integration time of each pixel is the same, but the time at which integration is taken is different for each pixel. As such, care must be taken when detecting incident light that varies over time.

Information described in this material is current as of February 2024.

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